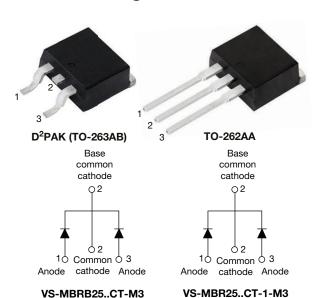
VS-MBRB25..CT-M3, VS-MBR25..CT-M3

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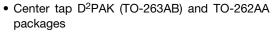
High Performance Schottky Rectifier, 2 x 15 A



PRIMARY CHARACTERISTICS						
I _{F(AV)}	2 x 15 A					
V_{R}	35 V, 45 V					
V _F at I _F	See datasheet					
I _{RM} max.	40 mA at 125 °C					
T _J max.	150 °C					
E _{AS}	16 mJ					
Package	D ² PAK (TO-263AB), TO-262AA					
Circuit configuration	Common cathode					

FEATURES

• 150 °C T_J operation





- Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform (per device)	30	^			
I _{FRM}	T _C = 130 °C (per leg)	30	A			
V _{RRM}		35/45	V			
I _{FSM}	$t_p = 5 \mu s sine$	1060	Α			
V _F	30 A _{pk} , T _J = 125 °C	0.73	V			
T _J	Range	-65 to +150	°C			

VOLTAGE RATINGS						
PARAMETER	SYMBOL	VS-MBRB2535CT-M3 VS-MBR2535CT-1-M3	VS-MBRB2545CT-M3 VS-MBR2545CT-1-M3	UNITS		
Maximum DC reverse voltage	V_R	35	45	V		
Maximum working peak reverse voltage	V_{RWM}		45	V		



VS-MBRB25..CT-M3, VS-MBR25..CT-M3

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ABSOLUTE MAXIMUM RATI	NGS				
PARAMETER	SYMBOL	TEST	VALUES	UNITS	
Maximum average per leg		T 400 00 mindy		15	
forward current per device	I _{F(AV)}	$I_C = 130^{\circ} \text{ C}, \text{ rated } V_R$	$T_C = 130 ^{\circ}\text{C}$, rated V_R		
Peak repetitive forward current per leg	I _{FRM}	I _{FRM} Rated V _R , square wave, 20 kHz, T _C = 130 °C		30	
Non-repetitive peak surge current	I _{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated V _{RRM} applied	1060	А
		Surge applied at rated load conditions halfwave, single phase, 60 Hz		150	
Non-repetitive avalanche energy per leg	E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 2 \text{A}, L = 8 \text{mH}$		16	mJ
Repetitive avalanche current per leg	I _{AR}	Current decaying linear Frequency limited by T	rly to zero in 1 μs σ maximum V _A = 1.5 x V _R typical	2	Α

ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS			
Maximum forward voltage drop	V _{FM} ⁽¹⁾	30 A	T _J = 25 °C	0.82	V	
Maximum forward voltage drop	VFM (*)	30 A	T _J = 125 °C	0.73	V	
Maximum instantaneous	I _{RM} ⁽¹⁾	T _J = 25 °C Rated DC voltage		0.2	mA	
reverse current	'RM '''	T _J = 125 °C	- hated DC voltage	40	IIIA	
Threshold voltage	V _{F(TO)}	T. T		0.355	V	
Forward slope resistance	r _t	$T_J = T_J$ maximum		12.3	mΩ	
Maximum junction capacitance	C _T	V _R = 5 V _{DC} (test signal range	ge 100 kHz to 1 MHz), 25 °C	700	pF	
Typical series inductance	L _S	Measured from top of term	8.0	nH		
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs	

Note

 $^{(1)}$ Pulse width < 300 μ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction temperature range		TJ		-65 to 150	°C		
Maximum storage temperature range		T _{Stg}		-65 to 175			
Maximum thermal resistance, junction to case per leg		R _{thJC}	DC operation				
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50	°C/W		
Anavovimenta weight				2	g		
Approximate weight				0.07	OZ.		
Maunting tayous	minimum		Non-lubricated threads	6 (5)	kgf · cm		
wounting torque	Mounting torque — maximum		Non-jubricated trireads	12 (10)	(lbf ⋅ in)		
Marking davisa			Case style D ² PAK (TO-263AB)	MBRB2 MBRB2	2535CT 2545CT		
Marking device			Case style TO-262AA	MBR25 MBR25			

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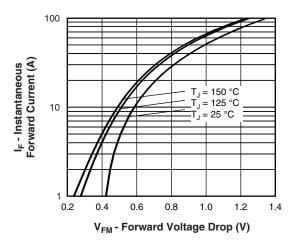


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

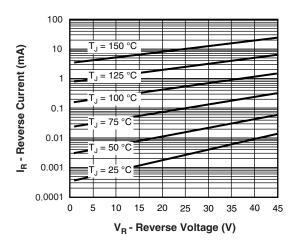


Fig. 2 - Typical Values of Reverse Current vs.Reverse Voltage (Per Leg)

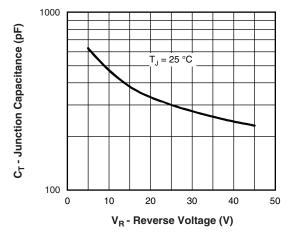


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

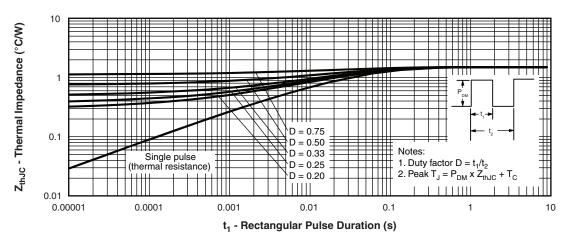


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

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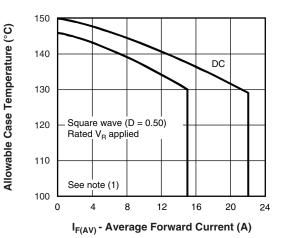


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

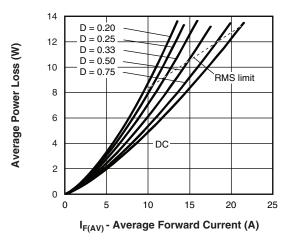


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

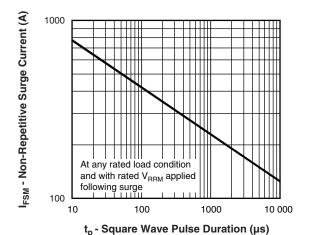


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

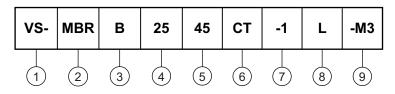
(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; $Pd = forward power loss = I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} = inverse power loss = V_{R1} \times I_R$ (1 - D); I_R at $V_{R1} = rated V_R$

VS-MBRB25..CT-M3, VS-MBR25..CT-M3

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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Essential part number

 \bullet B = D²PAK (TO-263AB) 7 None

• None = TO-262AA **7** = -1

- Current rating (25 = 25 A)

Voltage ratings 35 = 35 V 45 = 45 V

6 - CT = essential part number

7 - • None = D^2PAK (TO-263AB) 3 = B

• -1 = TO-262AA **3** None

8 - • None = tube

5

• L = tape and reel (left oriented - for D²PAK (TO-263AB) only)

• R = tape and reel (right oriented - for D²PAK (TO-263AB) only)

9 - -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION					
VS-MBRB2535CTL-M3	800	13" diameter plastic tape and reel					
VS-MBRB2535CT-M3	50	Antistatic plastic tubes					
VS-MBRB2535CTR-M3	800	13" diameter plastic tape and reel					
VS-MBRB2545CTL-M3	800	13" diameter plastic tape and reel					
VS-MBRB2545CT-M3	50	Antistatic plastic tubes					
VS-MBRB2545CTR-M3	800	13" diameter plastic tape and reel					
VS-MBR2535CT-1-M3	50	Antistatic plastic tubes					
VS-MBR2545CT-1-M3	50	Antistatic plastic tubes					

	LINKS TO RELATED DOCUMENTS						
Dimensions D ² PAK (TO-263AB) <u>www.vishay.com/doc?96164</u>							
Dimensions	TO-262AA	www.vishay.com/doc?96165					
Part marking information	D ² PAK (TO-263AB)	www.vishay.com/doc?95444					
	TO-262AA	www.vishay.com/doc?95443					
Packaging information		www.vishay.com/doc?96424					



Vishay Semiconductors

D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	ETERS	INC	HES	NOTES		SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

Revision: 13-Jul-17 Document Number: 96164



Vishay Semiconductors

TO-262AA

DIMENSIONS in millimeters and inches

Modified JEDEC® outline TO-262







⊕ 0.010 **M** A**M** B

Lead assignments



Diodes 1. - Anode (two die)/open (one die)

2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

	I		T				
SYMBOL	MILLIM	IETERS	INC	INCHES			
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES		
Α	4.06	4.83	0.160	0.190			
A1	2.03	3.02	0.080	0.119			
b	0.51	0.99	0.020	0.039			
b1	0.51	0.89	0.020	0.035	4		
b2	1.14	1.78	0.045	0.070			
b3	1.14	1.73	0.045	0.068	4		
С	0.38	0.74	0.015	0.029			
c1	0.38	0.58	0.015	0.023	4		
c2	1.14	1.65	0.045	0.065			
D	8.51	9.65	0.335	0.380	2		
D1	6.86	8.00	0.270	0.315	3		
E	9.65	10.67	0.380	0.420	2, 3		
E1	7.90	8.80	0.311	0.346	3		
е	2.54	BSC	0.100) BSC			
L	13.46	14.10	0.530	0.555			
L1	-	1.65	-	0.065	3		
L2	3.56	3.71	0.140	0.146			

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
 (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- Controlling dimension: inches
- Outline conform to JEDEC® TO-262 except A1 (max.), b (min., max.), b1 (min.), b2 (max.), c (min.), c1(min.), c2 (max.), D (min.), E (max.), L1 (max.), L2 (min., max.)



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